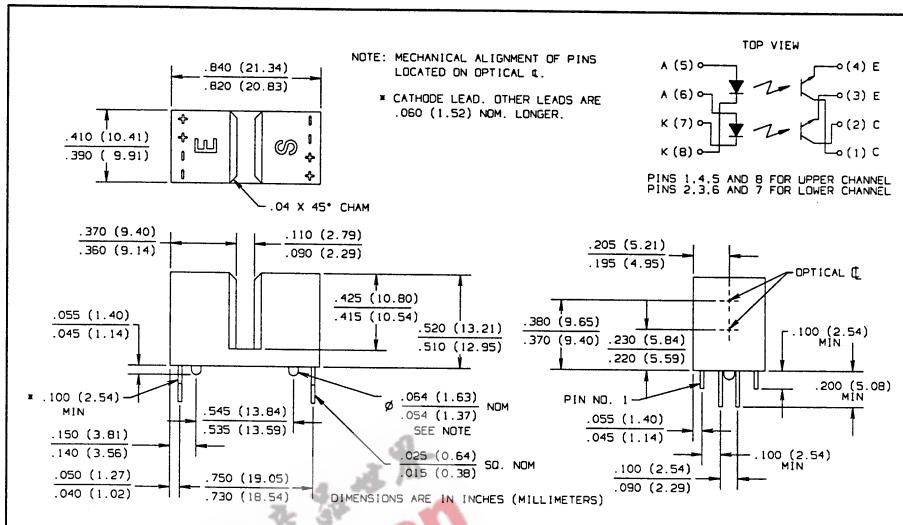
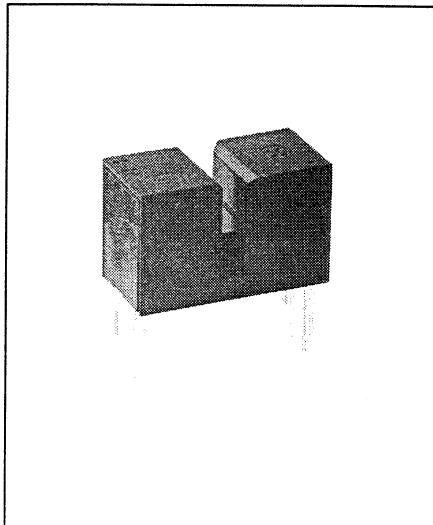


Dual Channel Slotted Optical Switches

Types OPB826S, OPB826SD



Features

- Dual channels over/under
- Direction of travel sensing
- Single or double apertures for high resolution
- 0.100" (2.54 mm) wide slot
- OPB826S (apertures on sensors only)
- OPB826SD (apertures on both emitters and sensors)

Description

The OPB826S and OPB826SD each consist of two infrared emitting diodes and two NPN silicon phototransistors mounted in an over/under configuration on opposite sides of a 0.100" (2.54 mm) wide slot. Phototransistor switching takes place when an opaque object passes through the slot. The OPB826S has 0.010" (0.25 mm) by 0.040" (1.02 mm) apertures in front of both phototransistors. The OPB826SD has the same sized apertures in front of both phototransistors and both emitters. Dual channels enable direction of travel sensing. The low cost IR transmissive plastic housing reduces possible interference from ambient light and provides dust and dirt protection.

Dual channel (side-by-side) configuration available as OPB822 series.

Absolute Maximum Ratings ($T_A = 25^\circ C$ unless otherwise noted)

Storage and Operating Temperature -40 $^\circ C$ to +85 $^\circ C$
Lead Soldering Temperature [1/16 inch (1.6 mm) from case for 5 sec. with soldering iron] 240 $^\circ C$

Input Diode

Continuous Forward Current	40 mA
Peak Forward Current (1 μ s pulse width, 300 pps)	3.0 A
Reverse Voltage	2.0 V
Power Dissipation	100 mW ⁽²⁾

Output Phototransistor(s)

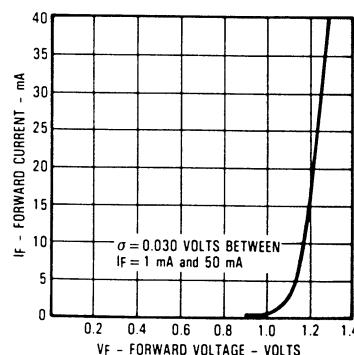
Collector-Emitter Voltage	30 V
Emitter-Collector Voltage	5.0 V
Power Dissipation	100 mW ⁽²⁾

Notes:

- (1) RMA flux is recommended. Duration can be extended to 10 sec. max when flow soldering.
- (2) Derate linearly 1.67 mW/ $^\circ C$ above 25 $^\circ C$.
- (3) Methanol or isopropanol are recommended as cleaning agents. Plastic housing is soluble in chlorinated hydrocarbons and ketones.
- (4) All parameters tested using pulse technique.

Typical Performance Curves

Forward Current
vs Forward Voltage Input Diode



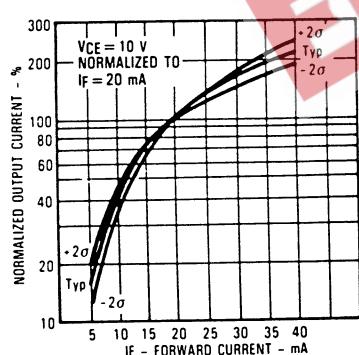
Types OPB826S, OPB826SD

Electrical Characteristics ($T_A = 25^\circ C$ unless otherwise noted)

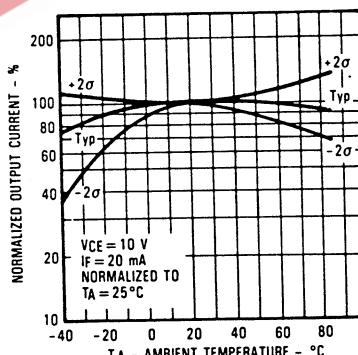
SYMBOL	PARAMETER		MIN	MAX	UNITS	TEST CONDITIONS
Input Diode						
V_F	Forward Voltage		1.70		V	$I_F = 20 \text{ mA}$
I_R	Reverse Current		100		μA	$V_R = 2 \text{ V}$
Output Phototransistor						
$V_{(BR)CEO}$	Collector-Emitter Breakdown Voltage	30			V	$I_C = 1 \text{ mA}$
$V_{(BR)ECO}$	Emitter-Collector Breakdown Voltage	5.0			V	$I_E = 100 \mu\text{A}$
I_{CEO}	Collector-Emitter Dark Current	100			nA	$V_{CE} = 10 \text{ V}, I_F = 0, E_e = 0$
Coupled						
$V_{CE(SAT)}$	Collector-Emitter Saturation Voltage	OPB826S OPB826SD	0.40 0.40		V	$I_C = 125 \mu\text{A}, I_F = 20 \text{ mA}$ $I_C = 50 \mu\text{A}, I_F = 20 \text{ mA}$
$I_{C(ON)}$	On-State Collector Current	OPB826S OPB826SD	250 100		μA	$V_{CE} = 10 \text{ V}, I_F = 20 \text{ mA}$ $V_{CE} = 10 \text{ V}, I_F = 20 \text{ mA}$
I_{Cx1}	Crosstalk	OPB826S OPB826SD	20 10		μA	$I_{F1} = 0 \text{ mA}, I_{F2} = 20 \text{ mA}, V_{CE} = 10 \text{ V}$ $I_{F1} = 0 \text{ mA}, I_{F2} = 20 \text{ mA}, V_{CE} = 10 \text{ V}$
I_{Cx2}	Crosstalk	OPB826S OPB826SD	20 10		μA	$I_{F1} = 20 \text{ mA}, I_{F2} = 0 \text{ mA}, V_{CE} = 10 \text{ V}$ $I_{F1} = 20 \text{ mA}, I_{F2} = 0 \text{ mA}, V_{CE} = 10 \text{ V}$

Typical Performance Curves

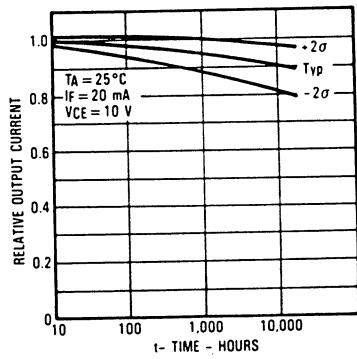
Normalized Output Current
vs Input Current



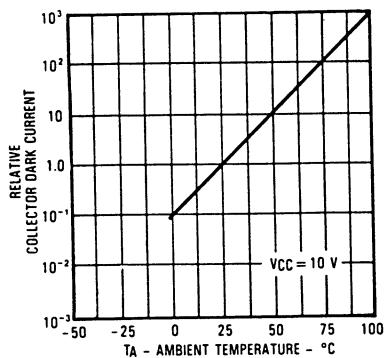
Normalized Output Current
vs Ambient Temperature



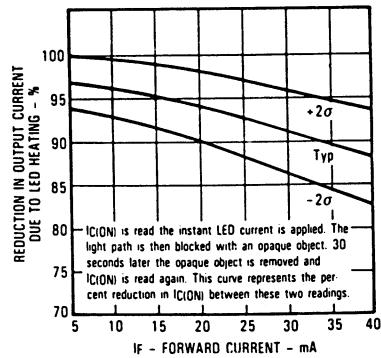
Relative Output Current
vs Time



Relative Collector Dark Current
vs Ambient Temperature



Reduction in Output Current Due to
LED Heating vs Forward Current



Rise and Fall Time
vs Load Resistance

